## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akram et al.

Serial No.: 09/832.160

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For: WAFER-LEVEL PACKAGE AND

METHODS OF FABRICATING

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## FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES RELATING TO MAINTENANCE FEES

Mail Stop ISSUE FEE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:

MICRON TECHNOLOGY, INC. Mail Stop 525 8000 South Federal Way Boise, Idaho 83707-0006

Serial No.: 09/832,160

- The Customer Number for the Fee Addressee is 26809.
- 3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
- It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,

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